

L Number	Hits	Search Text	DB	Time stamp
1	29	underfill\$3 and wafer near3 scale and (cte thermal near3 coefficient\$1)	USPAT	2003/01/26 09:42
2	0	(underfill\$3 and wafer near3 scale and (cte thermal near3 coefficient\$1)) and underfill\$3 same (ketone\$1 pentanone)	USPAT	2003/01/26 09:43
3	6	under\$1fill\$3 same (ketone\$1 pentanone)	USPAT	2003/01/26 09:54
4	34	under\$1fill\$3 and (solvent\$1 diluent\$1) same (ketone\$1 pentanone)	USPAT	2003/01/26 10:25
5	28	(under\$1fill\$3 and (solvent\$1 diluent\$1) same (ketone\$1 pentanone)) not (under\$1fill\$3 same (ketone\$1 pentanone))	USPAT	2003/01/26 09:55
12	0	under\$1fill\$3 and (solvent\$1 diluent\$1) same (ketone\$1 pentanone)	EPO; JPO	2003/01/26 10:26
15	1631	(epoxy resin\$1) and (solvent\$1 diluent\$1) same (ketone\$1 pentanone)	EPO; JPO	2003/01/26 10:26
18	121	((epoxy resin\$1) and (solvent\$1 diluent\$1) same (ketone\$1 pentanone)) and (epoxy resin\$1) and (solvent\$1 diluent\$1) same (ketone\$1 near3 isobutyl pentanone)	EPO; JPO	2003/01/26 10:27